Docket No.

ES PATENT AND TRADEMARK OFFICE

IN RE APPLICATION OF:

Yasuji HIRAMATSU, et al.

SERIAL NO:

10/069,510

GAU:

3742

FILED:

June 20, 2002

EXAMINER: FUQUA, SHAWNTINA T

FOR:

HOT PLATE FOR SEMICONDUCTOR PRODUCING/EXAMINING DEVICE

INFORMATION DISCLOSURE STATEMENT UNDER 37 CFR 1.97

COMMISSIONER FOR PATENTS ALEXANDRIA, VIRGINIA 22313

Applicant(s) wish to disclose the following information.

RECEIVED

MAR 0 1 2004

REFERENCES

- TECHNOLOGY CENTER FINDS

 The applicant(s) wish to make of record the references listed on the attached form PTO-1449. Copies of the listed references are attached, where required, as are either statements of relevancy or any readily available English translations of pertinent portions of any non-English language references.
- ☐ A check or credit card payment form is attached in the amount required under 37 CFR §1.17(p).

RELATED CASES

- Attached is a list of applicant's pending application(s) or issued patent(s) which may be related to the present application. A copy of the patent(s), together with a copy of the claims and drawings of the application(s) is attached along with PTO 1449.
- A check or credit card payment form is attached in the amount required under 37 CFR §1.17(p).

CERTIFICATION

- ☐ Each item of information contained in this information disclosure statement was first cited in any communication from a foreign patent office in a counterpart foreign application not more than three months prior to the filing of this statement.
- □ No item of information contained in this information disclosure statement was cited in a communication from a foreign patent office in a counterpart foreign application or, to the knowledge of the undersigned, having made reasonable inquiry, was known to any individual designated in 37 CFR §1.56(c) more than three months prior to the filing of this statement.

DEPOSIT ACCOUNT

Please charge any additional fees for the papers being filed herewith and for which no check or credit card payment is enclosed herewith, or credit any overpayment to deposit account number 15-0030. A duplicate copy of this sheet is enclosed.

Respectfully submitted,

03/01/2004 RMEBRAHT 00000137 10069510

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180.00 OP

Customer Number

22850

Tel. (703) 413-3000 Fax. (703) 413-2220 (OSMMN 05/03) I:\EM\EMREL\219s-220s\220254US TR. LETTER.DOC Registration No. 47,301

Masavasu Mori

Joseph A. Scafetta, Jr. Registration No. 26, 803

OBLON, SPIVAK, McCLELLAND,

MAIER & NEUSTADT, P.C.

Form PTO 1449 U.S. DEPARTMENT OF COM (Modified) PADE THE TOTAL AND TRADEMARK		OF COMMERCE	ATTY DOCKET NO.		SERIAL NO.			
(Modified)	R	ADEMANT AND TRAD	EMARK OFFICE	220254US2PCT		10/069,510		
		APPLICANT						
LIST OF REFERENCES CITED BY APPLICANT			Yasuji HIRAMATSU, et al.					
				FILING DATE		GROUP		
				June 20, 2002		3742		
				U.S. PATENT DOCUMENTS		Dr		
EXAMINER INITIAL		DOCUMENT NUMBER	DATE	NAME	CLASS	SUB CLASS	CE	LING DATE PROPRIATE 2004
	8	6,507,006	01/14/03	HIRAMATSU et al.	_	MAR		
	AB	6,465,763	10/15/02	ITO et al.	TEG	HNOUS	01	2004
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	AV							
OTHER REFERENCES (Including Author, Title, Date, Pertinent Pages, etc.)								
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	AY							
	AZ				Addi	tional Refe	erences	sheet(s) attached
Examiner					Date Cor	nsidered		
*Examiner: Initial if reference is considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.								

LIST OF RELATED CASES

Docket Number	Serial or Patent Number	Filing or <u>Issue Date</u>	Inventor/ Applicant
PER CLIENT	09/471,759	12/23/99	SAITO et al.
PER CLIENT	09/462,067	01/05/01	FURUKAWA et al.
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